# Small switching (60V, 10A) 25K2095N

### Features

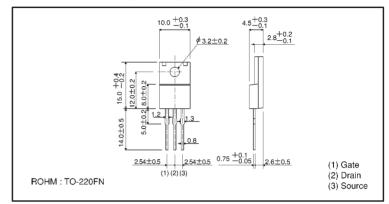
- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Wide SOA (safe operating area).
- 4) Easily designed drive circuits.
- 5) Low V<sub>GS(th)</sub>.
- 6) Easy to parallel.

### Structure

Silicon N-channel

**MOSFET** 

### External dimensions (Units: mm)



# ●Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		Voss	60	٧
Gate-source voltage		Vgss	±20	٧
Drain current	Continuous	ΙD	10	Α
	Pulsed	lpp*	40	Α
Reverse drain current	Continuous	IDR	10	Α
	Pulsed	lorp*	40	Α
Total power dissipation (Tc=25°C)		Po	30	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	<b>−55∼+150</b>	್ಥಿ

<sup>\*</sup> Pw≦10 μs, Duty cycle≦1%

### Packaging specifications

	Package	Bulk
Туре	Code	_
	Basic ordering unit (pieces)	500
2SK2095N		0



Transistors 2SK2095N

## ●Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Gate-source leakage	lgss	_	_	±100	nA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V(BR)DSS	60	_	_	٧	ID=1mA, VGS=0V
Zero gate voltage drain current	loss	_	_	100	μΑ	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V
Gate threshold voltage	VGS(th)	1.0	_	2.5	٧	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA
Static drain-source on-state resistance	RDS(on)	_	0.080	0.095	Ω	Ip=5A, Vgs=10V
		_	0.11	0.14		ID=5A, VGS=4V
Forward transfer admittance	Yfs  *	5.0	_	_	S	ID=5A, VDS=10V
Input capacitance	Ciss	_	1600	_	рF	V <sub>DS</sub> =10V
Output capacitance	Coss	_	600	_	рF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	_	150	_	рF	f=1MHz
Turn-on delay time	td(on)	_	30	_	ns	ID=5A, VDD≒30V
Rise time	tr	_	80	_	ns	V <sub>GS</sub> =10V
Turn-off delay time	td(off)	_	300	_	ns	RL=6Ω
Fall time	tr	_	100	_	ns	R <sub>G</sub> =10Ω

<sup>\*</sup> Pw≤300 μs, Duty cycle≤1%

### Electrical characteristic curves

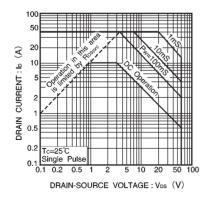


Fig.1 Maximum safe operating area

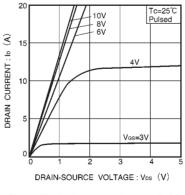


Fig.2 Typical output characteristics

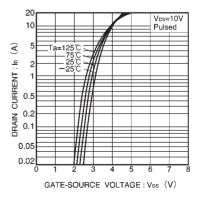


Fig.3 Typical transfer characteristics

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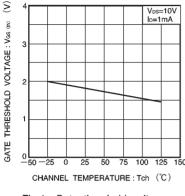


Fig.4 Gate threshold voltage vs. channel temperature

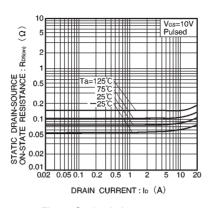


Fig.5 Static drain-source on-state resistance vs. drain current ( I )

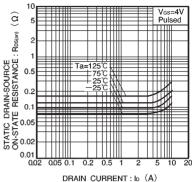


Fig.6 Static drain-source on-state resistance vs. drain current (II)

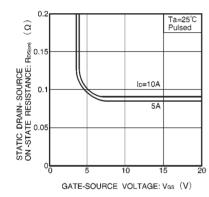


Fig.7 Static drain-source on-state resistance vs. gate-source voltage

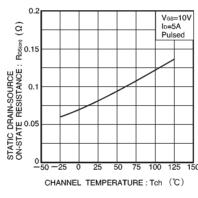


Fig.8 Static drain-source on-state resistance vs. channel temperature

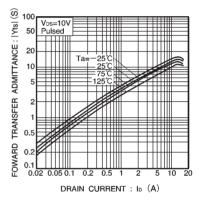


Fig.9 Forward transfer admittance vs. drain current

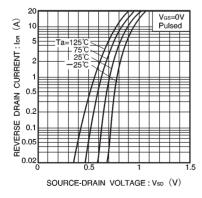


Fig.10 Reverse drain current vs. source-drain voltage (I)

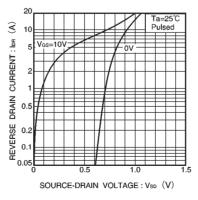


Fig.11 Reverse drain current vs. source-drain voltage (II)

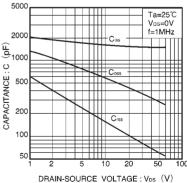
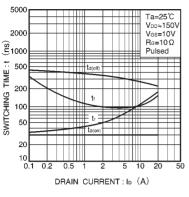


Fig.12 Typical capacitance vs. drain-source voltage

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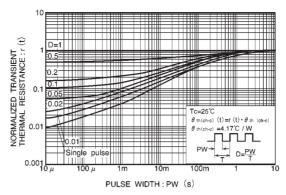
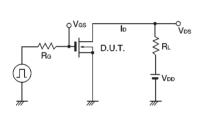


Fig.13 Switching characteristics (See Figures 15 and 16 for the measurement circuit and resultant waveforms.)

Fig.14 Normalized transient thermal resistance vs. pulse width

### Switching characteristics measurement circuit



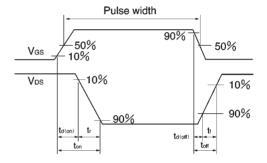


Fig.15 Switching time measurement circuit

Fig.16 Switching time waveforms

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